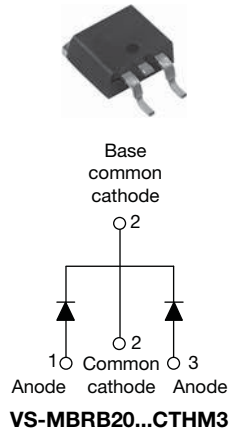
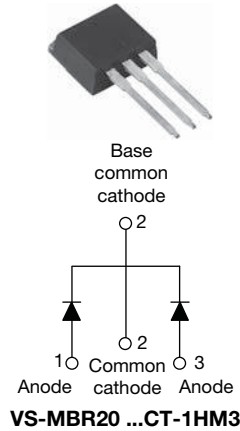


## High Performance Schottky Rectifier, 2 x 10 A

**TO-263AB (D<sup>2</sup>PAK)**

**TO-262AA**


### FEATURES

- 150 °C T<sub>J</sub> operation
- Low forward voltage drop
- High frequency operation
- Center tap D<sup>2</sup>PAK and TO-262 packages
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified, meets JESD 201 class 1 whisker test
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**

### PRODUCT SUMMARY

Package	TO-263AB (D <sup>2</sup> PAK), TO-262AA
I <sub>F(AV)</sub>	2 x 10 A
V <sub>R</sub>	80 V, 100 V
V <sub>F</sub> at I <sub>F</sub>	0.70 V
I <sub>RM</sub>	6 mA at 125 °C
T <sub>J</sub> max.	150 °C
Diode variation	Common cathode
E <sub>AS</sub>	24 mJ

### DESCRIPTION

This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

### MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
I <sub>F(AV)</sub>	Rectangular waveform (per device)	20	A
I <sub>FRM</sub>	T <sub>C</sub> = 133 °C (per leg)	20	
V <sub>R</sub>		80 to 100	V
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	850	A
V <sub>F</sub>	10 A <sub>pk</sub> , T <sub>J</sub> = 125 °C	0.70	V
T <sub>J</sub>	Range	-55 to +150	°C

### VOLTAGE RATINGS

PARAMETER	SYMBOL	VS-MBRB2080CTHM3 VS-MBR2080CT-1HM3	VS-MBRB2090CTHM3 VS-MBR2090CT-1HM3	VS-MBRB20100CTHM3 VS-MBR20100CT-1HM3	UNITS
Maximum DC reverse voltage	V <sub>R</sub>	80	90	100	V
Maximum working peak reverse voltage	V <sub>RWM</sub>				



ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	$I_{F(AV)}$	$T_C = 133\text{ }^\circ\text{C}$ , rated $V_R$	per leg	10	A
			per device	20	
Peak repetitive forward current per leg	$I_{FRM}$	Rated $V_R$ , square wave, 20 kHz, $T_C = 133\text{ }^\circ\text{C}$		20	
Non-repetitive peak surge current	$I_{FSM}$	5 $\mu\text{s}$ sine or 3 $\mu\text{s}$ rect. pulse	Following any rated load condition and with rated $V_{RRM}$ applied	850	
		Surge applied at rated load conditions half wave, single phase, 60 Hz		150	
Peak repetitive reverse surge current	$I_{RRM}$	2.0 $\mu\text{s}$ , 1.0 kHz		0.5	
Non-repetitive avalanche energy per leg	$E_{AS}$	$T_J = 25\text{ }^\circ\text{C}$ , $I_{AS} = 2\text{ A}$ , $L = 12\text{ mH}$		24	mJ

ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop	$V_{FM}^{(1)}$	10 A	$T_J = 25\text{ }^\circ\text{C}$	0.80	V
		20 A		0.95	
		10 A	$T_J = 125\text{ }^\circ\text{C}$	0.70	
		20 A		0.85	
Maximum instantaneous reverse current	$I_{RM}^{(1)}$	$T_J = 25\text{ }^\circ\text{C}$	Rated DC voltage	0.10	mA
		$T_J = 125\text{ }^\circ\text{C}$		6	
Threshold voltage	$V_{F(TO)}$	$T_J = T_J$ maximum		0.433	V
Forward slope resistance	$r_t$			15.8	$\text{m}\Omega$
Maximum junction capacitance	$C_T$	$V_R = 5\text{ V}_{DC}$ (test signal range 100 kHz to 1 MHz), $25\text{ }^\circ\text{C}$		400	pF
Typical series inductance	$L_S$	Measured from top of terminal to mounting plane		8.0	nH
Maximum voltage rate of change	$dV/dt$	Rated $V_R$		10 000	$\text{V}/\mu\text{s}$

Note

(1) Pulse width < 300  $\mu\text{s}$ , duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum junction temperature range	$T_J$			-55 to +150	$^\circ\text{C}$
Maximum storage temperature range	$T_{Stg}$			-65 to +150	
Maximum thermal resistance, junction to case per leg	$R_{thJC}$	DC operation		2.0	$^\circ\text{C}/\text{W}$
Typical thermal resistance, case to heatsink	$R_{thCS}$	Mounting surface, smooth and greased		0.50	
Maximum thermal resistance, junction to ambient	$R_{thJA}$	DC operation		50	
Approximate weight				2	g
				0.07	oz.
Mounting torque	minimum	Non-lubricated threads		6 (5)	$\text{kgf} \cdot \text{cm}$ ( $\text{lbf} \cdot \text{in}$ )
	maximum			12 (10)	
Marking device		Case style D <sup>2</sup> PAK	MBRB2090CTH		
			MBRB2080CTH		
			MBRB20100CTH		
		Case style TO-262	MBR2090CT-1H		
			MBR2080CT-1H		
			MBR20100CT-1H		

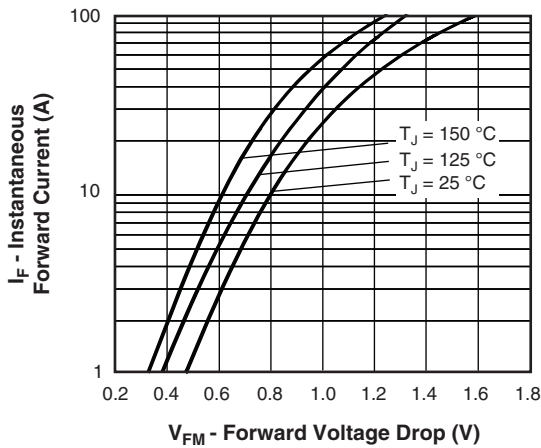


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

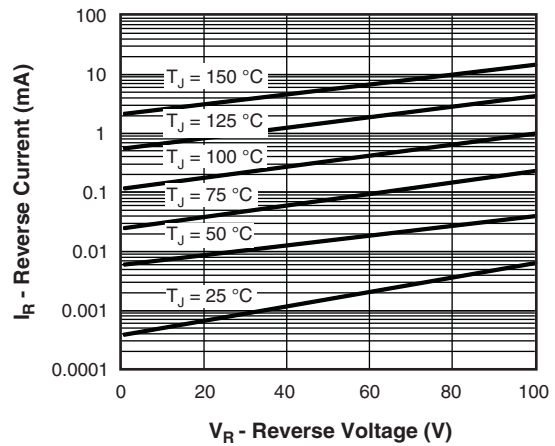


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

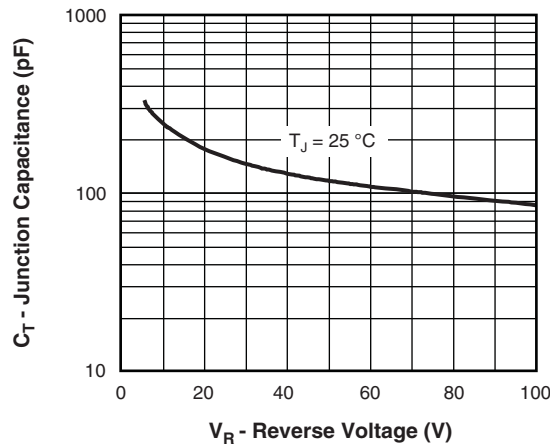


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

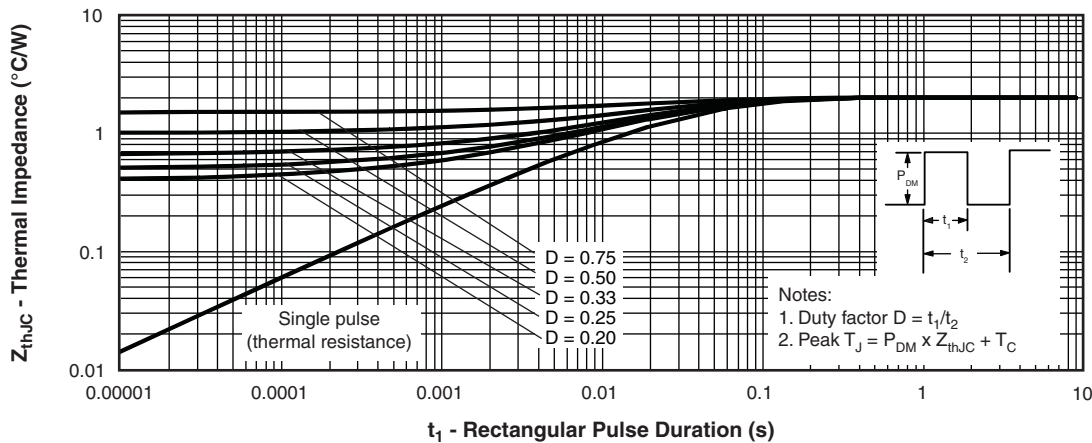


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (Per Leg)

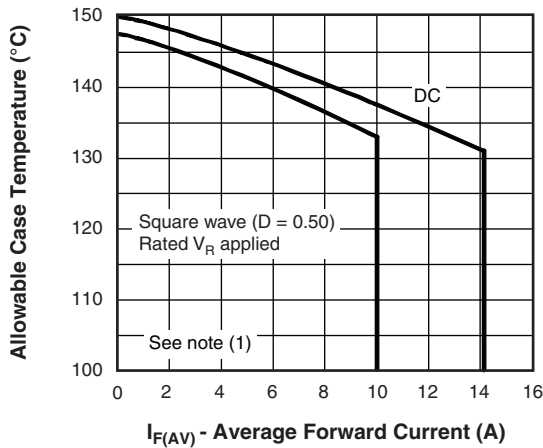


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

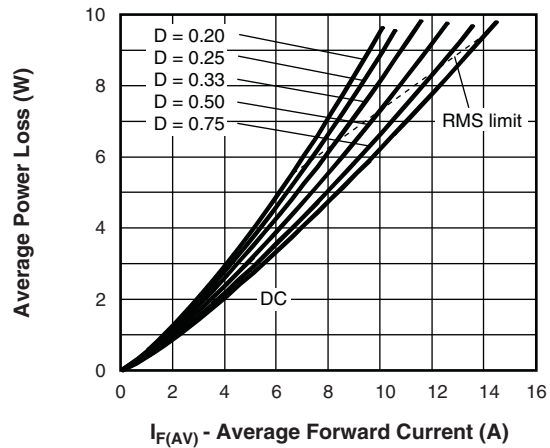


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

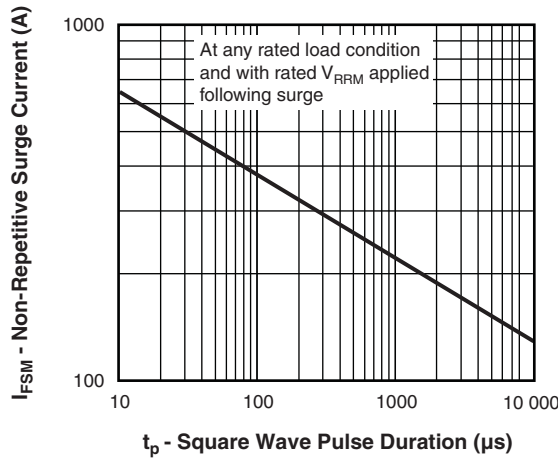


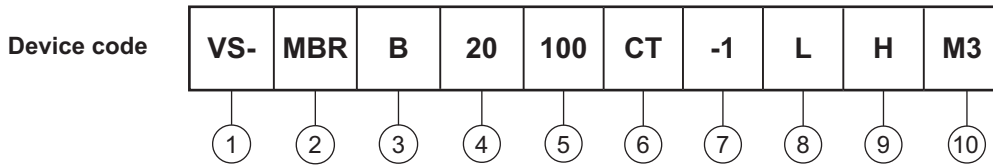
Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

**Note**

- (1) Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$ ;  
 $Pd$  = Forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6);  
 $Pd_{REV}$  = Inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = Rated  $V_R$



**ORDERING INFORMATION TABLE**



- 1** - Vishay Semiconductors product
- 2** - Essential part number
- 3** -
  - B = D<sup>2</sup>PAK     **7** None
  - None = TO-262   **7** = -1
- 4** - Current rating (20 = 20 A)
 

80 = 80 V
90 = 90 V
100 = 100 V
- 5** - Voltage ratings
- 6** - CT = common cathode
- 7** -
  - None = D<sup>2</sup>PAK   **3** = B
  - -1 = TO-262   **3** None
- 8** -
  - None = tube (50 pieces)
  - L = tape and reel (left oriented - for D<sup>2</sup>PAK only)
  - R = tape and reel (right oriented - for D<sup>2</sup>PAK only)
- 9** -
  - H = AEC-Q101 qualified
- 10** -
  - M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

<b>ORDERING INFORMATION (Example)</b>			
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-MBRB2080CTHM3	50	1000	Antistatic plastic tube
VS-MBRB2090CTHM3	50	1000	Antistatic plastic tube
VS-MBRB20100CTHM3	50	1000	Antistatic plastic tube
VS-MBRB2080CTLHM3	800	800	13" diameter reel
VS-MBRB2090CTLHM3	800	800	13" diameter reel
VS-MBRB20100CTLHM3	800	800	13" diameter reel
VS-MBRB2080CTRHM3	800	800	13" diameter reel
VS-MBRB2090CTRHM3	800	800	13" diameter reel
VS-MBRB20100CTRHM3	800	800	13" diameter reel
VS-MBRB2080CT-1HM3	50	1000	Antistatic plastic tube
VS-MBRB2090CT-1HM3	50	1000	Antistatic plastic tube
VS-MBRB20100CT-1HM3	50	1000	Antistatic plastic tube

<b>LINKS TO RELATED DOCUMENTS</b>		
Dimensions	TO-263AB (D <sup>2</sup> PAK)	<a href="http://www.vishay.com/doc?95046">www.vishay.com/doc?95046</a>
	TO-262AA	<a href="http://www.vishay.com/doc?95419">www.vishay.com/doc?95419</a>
Part marking information	TO-263AB (D <sup>2</sup> PAK)	<a href="http://www.vishay.com/doc?95444">www.vishay.com/doc?95444</a>
	TO-262AA	<a href="http://www.vishay.com/doc?95443">www.vishay.com/doc?95443</a>
Packaging information	TO-263AB (D <sup>2</sup> PAK)	<a href="http://www.vishay.com/doc?95032">www.vishay.com/doc?95032</a>

### D<sup>2</sup>PAK

#### DIMENSIONS in millimeters and inches

Conforms to JEDEC<sup>®</sup> outline D<sup>2</sup>PAK (SMD-220)



SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.			MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190		D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010		E	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039		E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4	e	2.54 BSC		0.100 BSC		
b2	1.14	1.78	0.045	0.070		H	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4	L	1.78	2.79	0.070	0.110	
c	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4	L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065		L3	0.25 BSC		0.010 BSC		
D	8.51	9.65	0.335	0.380	2	L4	4.78	5.28	0.188	0.208	

#### Notes

- Dimensioning and tolerancing per ASME Y14.5 M-1994
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- Thermal pad contour optional within dimension E, L1, D1 and E1
- Dimension b1 and c1 apply to base metal only
- Datum A and B to be determined at datum plane H
- Controlling dimension: inch
- Outline conforms to JEDEC<sup>®</sup> outline TO-263AB

## TO-262

**DIMENSIONS** in millimeters and inches

Modified JEDEC® outline TO-262



$\oplus 0.010 \text{ M} \text{ A} \text{ M} \text{ B}$



**Lead assignments**

- Diodes**  
 1. - Anode (two die)/open (one die)  
 2., 4. - Cathode  
 3. - Anode



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
e	2.54 BSC		0.100 BSC		
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.36	3.71	0.132	0.146	

**Notes**

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum), D1 (minimum) and L2 where dimensions derived the actual package outline



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